09/445, 892.

PTO/SB/21 (09-04) (AW 10/2004)

Approved for use through 7/31/2006. OMB 0651-003 U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number. 6,740,183 Patent Number TRANSMITTAL issue Date May 25, 2004 **FORM** 27 2006 Segawa et al. First Named Inventor FER Certificate (to be used for all correspondence after initial filing) 1734 Art Unit Melvin C. Mayes **Examiner Name** Total Number of Pages in This Submission $\, m{\mathscr{T}} \,$ Attorney Docket No. **MAT-7855US** ENCLOSURES (Check all that apply) After Allowance Communication Drawing(s) Fee Transmittal Form to TC Fee Attached Licensing-related Papers Appeal Communication to Board of Appeals and Interferences Petition Amendment/Reply After Final Appeal Communication to TC Petition to Convert to a (Appeal Notice, Brief, Reply Affidavits/Declaration(s) **Provisional Application** Brief) Power of Attorney, Revocation, Extension of Time Request Proprietary Information Change of Correspondence Address Status Letter **Express Abandonment Request** Terminal Disclaimer Other Enclosure(s) (please Information Disclosure Statement Request for Refund identify below): Request for Reconsideration under 37 C.F.R. §1.322; CD, Number of CD(s) Certified Copy of Priority Document(s) returned postcard Landscape Table on CD copy of Request for Certificate of Correction, Response to Missing Parts/

Remarks: SIGNATURE OF APPLICANT, ATTORNEY OR AGENT **Rat**nerPrestia Firm Name Signature Lawrence E. Ashery Printed Nary 34,515 February 24, 2006 Registration No. Date

CERTIFICATE OF TRANSMISSION / MAILING

I hereby certify that this correspondence is being facsimile transmitted to the USPTO or deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date shown be per for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date shown below:

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Incomplete Application

Response to Missing Parts

under 37 CFR 1.52 or 1.53

Fran Petrillo

Date

February 24, 2006

PTO Form 1050,

up specification

pages 1 and 12 of marked-

This collection of information is required by 37 CFR 1.5. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.11 and 1.14. This collection is estimated to take 2 hours to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Office, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, ALEXANDRIA, VA 22313-1450. MAT-7855US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Number:

6,740,183 May 25, 2004

Name of Patentee:

Segawa et al.

Title of Invention:

METHOD OF PRODUCING CERAMIC MULTI-LAYERED SUBSTRATE

REQUEST FOR RECONSIDERATION UNDER 37 C.F.R. § 1.322

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

This Request is being filed to request consideration of a Request for Certificate of Correction which was previously filed on November 4, 2004 (copy enclosed).

The Request for Certificate of Correction states that there are errors on the title page, in the Abstract. The Abstract should read as amended in the Marked-up Copy of Specification Showing Additions and Deletions (copy enclosed).

It is respectfully requested that these errors be corrected in a Certificate of Correction.

Respectfully submitted

Lawrence E. Ashery, Reg. No. 34,515 Attorney for Applicants

LEA/dlm

Enclosure:

Copy of Request for Certificate of Correction

Copy of pages 1 and 12 of Marked-up

Copy of Specification

Dated: April 13, 2005

P.O. Box 980 Valley Forge, PA 19482 (610) 407-0700

The Commissioner for Patents is hereby authorized to charge payment to Deposit Account No. 18-0350 of any fees associated with this communication.

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, with sufficient postage, in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 Attn: Decision and Certificate of Correction Branch of the Patent Issue Division on:

April 13, 2005

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| | Commissioner for Patents: Date: 13 2005 | |
|----|--|---|
| | Please acknowledge receipt of the document(s) described below by imprinting the Patent and Trademark Office "date-stamp" hereon and returning this card to the addressee indicated on the reverse side. | |
| | FILE NO. MAT-7855US FEE DUE? NO or \$ OIPE | 1 |
| | NAME: SOUNA LT COL | |
| | ☐ Amendment (pp.) (PRELIMINARY: YES or NO) APR 1 5 2005 | |
| | ☐ Verification of a Translation ☐ Petition for Ext. of fine (2 □ □) | |
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| 1 | ☐ Form 1390 ☐ Certificate of Express Mailing | |
| ì | Assignment & Form 1595 (3 pp.) Sheets of Drawings (Formal) Submission of Formal Drawings | |
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COPY

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Number:

6,740,183

Issued:

May 25, 2004

Name of Patentee: Title of Invention: Segawa et al.
METHOD OF PRODUCING CERAMIC MULTI-LAYERED SUBSTRATE

REQUEST FOR CERTIFICATE OF CORRECTION OF PATENT FOR PTO MISTAKE (37 C.F.R. § 1.322(a))

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Attention:

Decision and Certificate of Correction

Branch of the Patent Issue Division

- Attached in duplicate is Form PTO-1050 with at least one copy being suitable for printing.
- 2. Correction of the Official Letters Patent is respectfully requested in view of the following text which appears correctly in the application file:

On the title page, in the abstract, line 2 of Letters Patent, delete "to remove a" and insert -- the removal of-- as indicated in line 3 on page 12 of the marked-up copy of specifications showing additions and deletions filed December 14, 1999.

On the title page, in the abstract, line 3 of Letters Patent, delete "sheet" and insert -- sheets-- as indicated in line 3 on page 12 of the marked-up copy of specifications showing additions and deletions filed December 14, 1999.

On the title page, in the abstract, line 4 of the Letters Patent delete "sheets are" and insert --sheet is-- as indicated in line 4 on page 12 of the marked-up copy of specifications showing additions and deletions filed December 14, 1999.

On the title page, in the abstract, line 6 of the Letters Patent delete "For removing the shrinkage suppression sheets, on both faces of the multi-layered ceramic substrate 2 after sintering , water" and insert --Water-- as indicated in line 6 on page 12 of the marked-up copy of specifications showing additions and deletions filed December 14, 1999.

On the title page, in the abstract, line 8 of the Letters Patent after "or" insert --a-- as indicated in line 7 on page 12 of the marked-up copy of specifications showing additions and deletions filed December 14, 1999.

On the title page, in the abstract, line 9 of Letters Patent after "sprayed" insert --,-- as indicated in line 8 on page 12 of the marked-up copy of specifications showing additions and deletions filed December 14, 1999.

On the title page, in the abstract, line 10 of Letters Patent after "air." insert --onto the shrinkage suppression sheets, on both faces of the multi-layered ceramic substrate, after sintering, to remove the shrinkage suppression sheets.-- as indicated in line 8 on page 12 of the marked-up copy of specifications showing additions and deletions filed December 14, 1999.

Please send the Certificate to:

Name:

P.O. Box 980 Valley Forge, PA 19482 (610) 407-0700

Name of Assignee: Matsushita Electrical Industrial Co., LTD.

Assignment Recorded on:

April 24, 2000

Reel:

010788

Frame:

0064

Respectfully submitted,

Lawrence E. Ashery, Reg. No. Attorney for Applicants

LEA/rrc

Enclosure: Form PTO-1050 (in duplicate)

Dated: November 4, 2004

P.O. Box 980 Valley Forge, PA 19482 (610) 407-0700

The Commissioner for Patents is hereby authorized to charge payment to Deposit Account No. 18-0350 of any fees associated with this communication.

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ovember 4, 2004

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UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO:

6,740, 183

DATED:

May 25, 2004

INVENTORS:

Segawa et al.

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Title page.

Item [57], ABSTRACT,

Line 2, delete "to remove a" and insert -- the removal of--.

Line 3, delete "sheet" and insert -- sheets--.

Line 4, delete " sheets are" and insert -- sheet is --.

Line 6, delete "For removing the shrinkage suppression sheets on both faces of the multi-layered ceramic substrate 2 after sintering, water" and insert --Water--.

Line 8, after "or" insert --a--.

Line 9, after "sprayed" insert --,--.

Line 10, after "air." insert --onto the shrinkage suppression sheets, on both faces of the multi-layered ceramic substrate, after sintering, to remove the shrinkage suppression sheets.--.

Mailing Address of Sender:

Patent No.

6,740, 183

RatnerPrestia P.O. Box 980 Valley Forge, PA 19482

(610) 407-0700

No. of Additional Copies:

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This collection of information is required by 37 CFR 1.322, 1.323 and 1.324. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 1.0 hour to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Attention Certificate of Corrections Branch, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

If you need assistance completing the form, call 1-800-PTO-9199 and select option 2.



FEB 27 2006

MARKED-UP COPY OF SPECIFICATION SHOWING ADDITIONS AND DELETIONS



METHOD FOR MANUFACTURING A MULTI-LAYERED CERAMIC
SUBSTRATE

FIELD OF THE INVENTION

The present invention relates to the field of methods for manufacturing a multi-layered ceramic substrate used for electronic devices, and in particular to methods for manufacturing a so-called-non-shrinkable multi-layered substrate which greatly suppresses shrinkage of the substrate during firing.

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BACKGROUND OF THE INVENTION

Normally, multi-layered ceramic substrates are manufactured using a method called the green sheet lamination method. In this method, green sheets, made by forming a slurry containing ceramic powder and organic binder into a sheet, are punched (for holes) and screen printed with conductive paste. These green sheets are stacked to the required number, press-heated to laminate the layers, and then fired.

The advantages of this method include the feasibility of fine pattern printing realized by the extremely flexible green sheet and good permeability to organic solvents; and good surface smoothness and air-tightness which allow the lamination of even up to several dozens of layers.

On the other hand, the main disadvantage is the difficulty in achieving dimensional accuracy. This is due to shrinkage of the ceramic substrate accompanied by sintering which occurs during firing-it. Inaccurate dimensions cause mismatching between components and conductive patterns, generating the serious problem of inability to mount semiconductor chips such as CSPs (chip size packages) and MCMs (multi-chip modules) with high accuracy.

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ABSTRACT OF THE DISCLOSURE

A method for manufacturing a multi-layered ceramic substrate which enables the removal of to remove a shrinkage suppression sheets without damaging the multi-layered substrate. The shrinkage suppression sheets is are formed on both faces of unfired laminated green sheets, and then the laminated green sheets are fired. For removing the shrinkage suppression sheets on both faces of the multi-layered ceramic substrate 2 after sintering, waterWater, ceramic powder, or a water and ceramic powder mixture is sprayed, together with compressed air. onto the shrinkage suppression sheets, on both faces of the multi-layered ceramic substrate, after sintering, for to removeal of the shrinkage suppression sheets.